



In re application of:  
Rich Fogal and Michael B. Ball

Serial No.: 09/422,887 ✓

Filed: October 21, 1999

For: ANGULARLY OFFSET STACKED  
DIE MULTICHIP DEVICE AND  
METHOD OF MANUFACTURE

§ Group Art Unit: 2822  
§  
§ Examiner: J. Brophy  
§  
§ Atty. Docket: 95-0134.05  
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Certificate of Mailing (37 C.F.R. § 1.8)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on the date below:

2/19/02  
Date

*Susan Jerome*  
Signature

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136(a)

Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

Applicants hereby petition to extend the period for response to the Office Action mailed October 17, 2001 for one (1) month(s), from January 17, 2002 to February 17, 2002.

☒ Because February 17, 2002 falls on a Sunday and February 18, 2002 is a holiday in the District of Columbia, the period for response extends to February 19, 2002.

Accordingly, the requisite fee is \$ 110. The Commissioner is requested to charge this fee, and any additional fee which may be required, to Micron Technology, Inc. Deposit Account 13-3092, Order No. 95-0134.05. A duplicate copy of this petition is enclosed.

Respectfully submitted,

*Charles B. Brantley*

Charles B. Brantley, II, Reg. No. 38,086  
Micron Technology, Inc.  
8000 S. Federal Way  
Boise, ID 83706-9632  
(208) 368-4557

Date: 2/19/02

03/07/2002 NMOHAMH1 00000028 133092 09422887

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